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Dated: November 24, 2009

Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80154(302728)  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Takashi Yamaguchi et al.

Application No.: 10/539,884

Confirmation No.: 6471

Filed: June 16, 2005

Art Unit: 1791

For: COMPOSITE OF ALUMINUM MATERIAL  
AND SYNTHETIC RESIN MOLDING AND  
PROCESS FOR PRODUCING THE SAME

Examiner: D. N. Bodawala

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir/Madam:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated June 24, 2009, enclosed herewith a two month Extension of Time and a revised Declaration, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 9 of this paper.